

PROTECTION PRODUCTS
Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P_{pk}	300	Watts
Thermal Resistance, Junction to Ambient	θ_{JA}	556	°C/W
Lead Soldering Temperature	T_L	260 (10 sec.)	°C
Operating Temperature	T_J	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Characteristics
SM05

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				5	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	6			V
Reverse Leakage Current	I_R	$V_{RWM} = 5V, T=25^{\circ}C$			20	μA
Clamping Voltage	V_C	$I_{PP} = 1A,$ $t_p = 8/20\mu s$			9.8	V
Peak Pulse Current	I_{PP}	$t_p = 8/20\mu s$			17	A
Junction Capacitance	C_j	Pin 1 to 2 $V_R = 0V, f = 1MHz$			350	pF
Junction Capacitance	C_j	Pin 1 to 3 and Pin 2 to 3 $V_R = 0V, f = 1MHz$			400	pF

SM12

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				12	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	13.3			V
Reverse Leakage Current	I_R	$V_{RWM} = 12V, T=25^{\circ}C$			1	μA
Clamping Voltage	V_C	$I_{PP} = 1A,$ $t_p = 8/20\mu s$			19	V
Peak Pulse Current	I_{PP}	$t_p = 8/20\mu s$			12	A
Junction Capacitance	C_j	Pin 1 to 2 $V_R = 0V, f = 1MHz$			120	pF
Junction Capacitance	C_j	Pin 1 to 3 and Pin 2 to 3 $V_R = 0V, f = 1MHz$			150	pF

PROTECTION PRODUCTS

Electrical Characteristics (Continued)

SM15

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				15	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	16.7			V
Reverse Leakage Current	I_R	$V_{RWM} = 15V, T=25^{\circ}C$			1	μA
Clamping Voltage	V_C	$I_{PP} = 1A, t_p = 8/20\mu s$			24	V
Peak Pulse Current	I_{PP}	$t_p = 8/20\mu s$			10	A
Junction Capacitance	C_J	Pin 1 to 2 $V_R = 0V, f = 1MHz$			75	pF
Junction Capacitance	C_J	Pin 1 to 3 and 2 to 3 $V_R = 0V, f = 1MHz$			100	pF

SM24

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				24	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	26.7			V
Reverse Leakage Current	I_R	$V_{RWM} = 24V, T=25^{\circ}C$			1	μA
Clamping Voltage	V_C	$I_{PP} = 1A, t_p = 8/20\mu s$			43	V
Peak Pulse Current	I_{PP}	$t_p = 8/20\mu s$			5	A
Junction Capacitance	C_J	Pin 1 to 2 $V_R = 0V, f = 1MHz$			50	pF
Junction Capacitance	C_J	Pin 1 to 3 and 2 to 3 $V_R = 0V, f = 1MHz$			60	pF

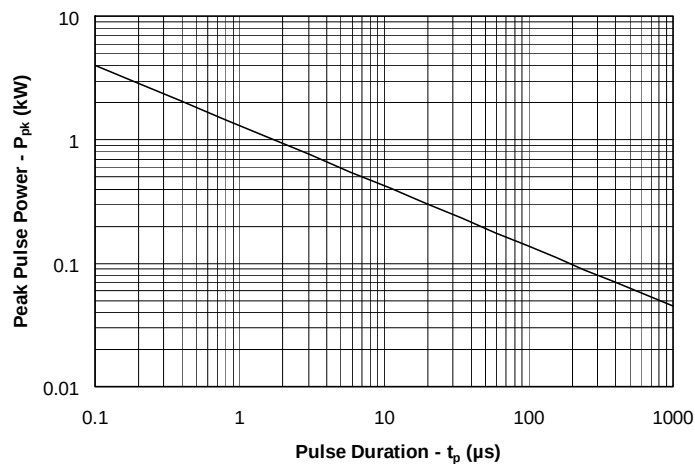
SM36

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				36	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	40			V
Reverse Leakage Current	I_R	$V_{RWM} = 36V, T=25^{\circ}C$			1	μA
Clamping Voltage	V_C	$I_{PP} = 1A, t_p = 8/20\mu s$			60	V
Peak Pulse Current	I_{PP}	$t_p = 8/20\mu s$			4	A
Junction Capacitance	C_J	Pin 1 to 2 $V_R = 0V, f = 1MHz$			40	pF
Junction Capacitance	C_J	Pin 1 to 3 and 2 to 3 $V_R = 0V, f = 1MHz$			45	pF

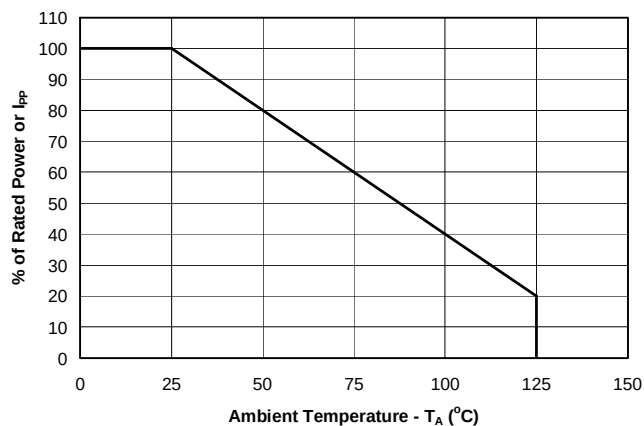
PROTECTION PRODUCTS

Typical Characteristics

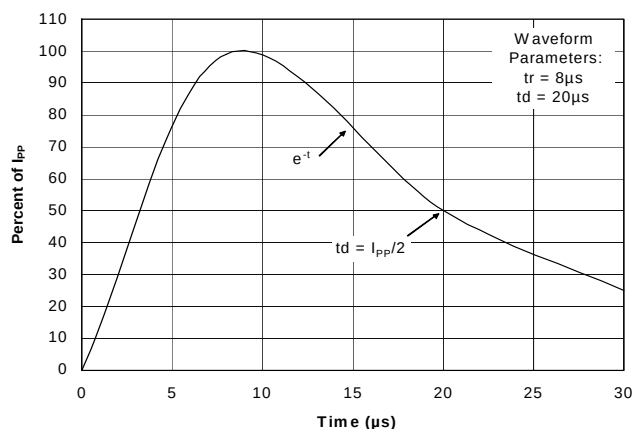
Non-Repetitive Peak Pulse Power vs. Pulse Time



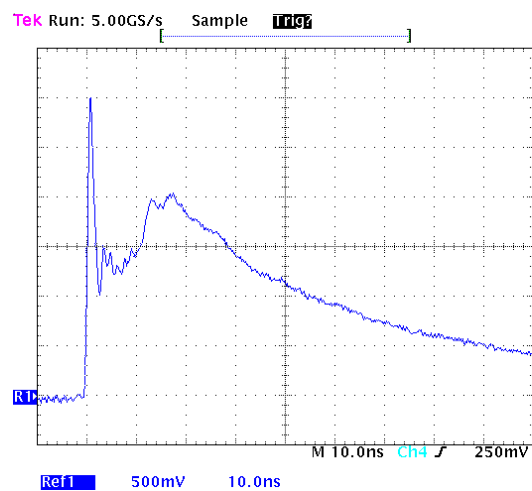
Power Derating Curve



Pulse Waveform



ESD Pulse Waveform (Per IEC 61000-4-2)



IEC 61000-4-2 Discharge Parameters

Level	First Peak Current (A)	Peak Current at 30 ns (A)	Peak Current at 60 ns (A)	Test Voltage (Contact Discharge) (kV)	Test Voltage (Air Discharge) (kV)
1	7.5	4	8	2	2
2	15	8	4	4	4
3	22.5	12	6	6	8
4	30	16	8	8	15

PROTECTION PRODUCTS

Applications Information

Device Connection Options

The SM series is designed to protect one bidirectional or two unidirectional data or I/O lines operating at 5 to 36 volts. Connection options are as follows:

- **Bidirectional:** Pin 1 is connected to the data line and pin 2 is connected to ground (Since the device is symmetrical, these connections may be reversed). The ground connection should be made directly to a ground plane. The path length should be kept as short as possible to minimize parasitic inductance. Pin 3 is not connected.
- **Unidirectional:** Data lines are connected to pin 1 and pin 2. Pin 3 is connected to ground. For best results, this pin should be connected directly to a ground plane on the board. The path length should be kept as short as possible to minimize parasitic inductance.

Circuit Board Layout Recommendations for Suppression of ESD.

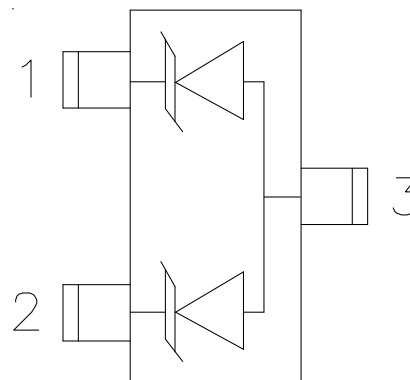
Good circuit board layout is critical for the suppression of fast rise-time transients such as ESD. The following guidelines are recommended (Refer to application note SI99-01 for more detailed information):

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

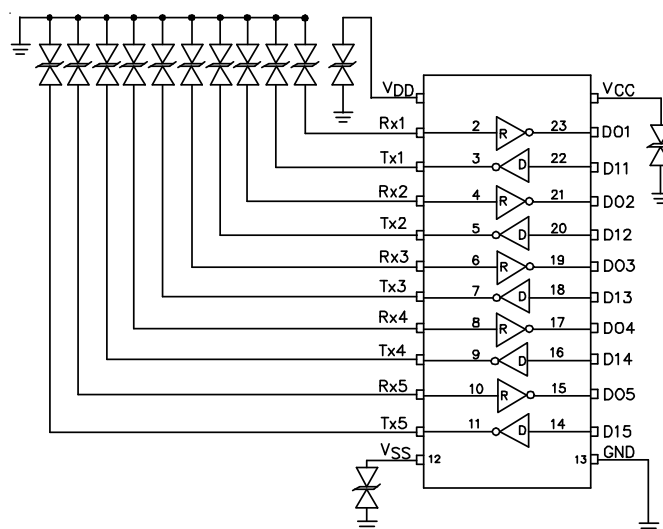
Matte Tin Lead Finish

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

Device Schematic & Pin Configuration

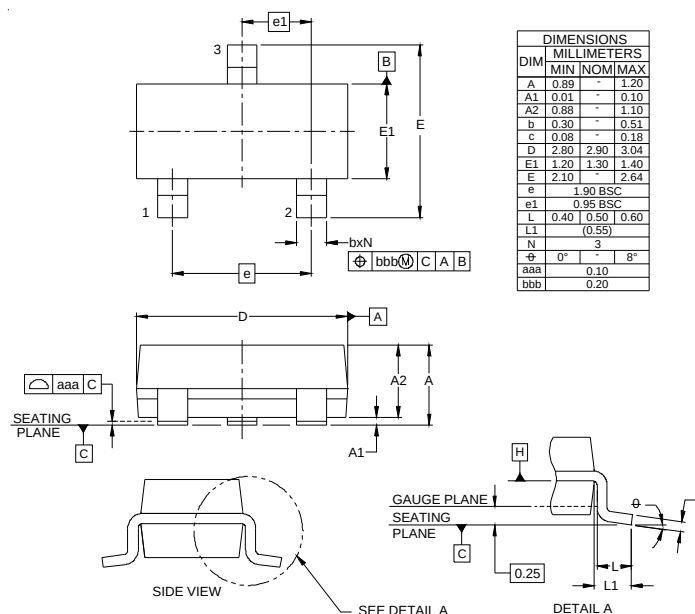


RS-232 Transceiver Protection Example



PROTECTION PRODUCTS

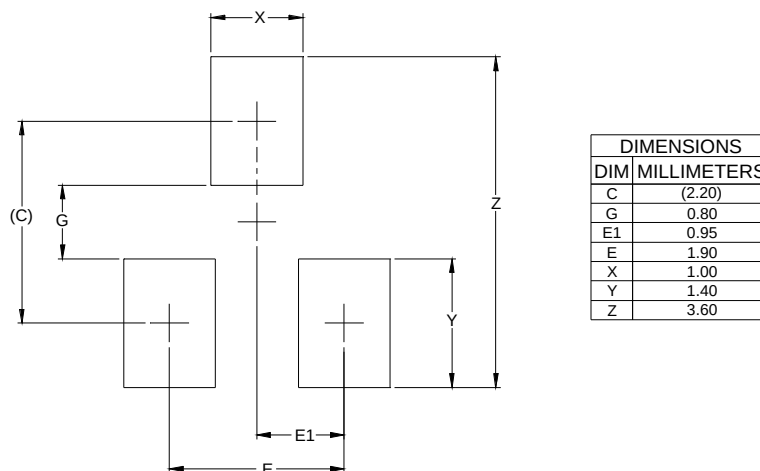
Outline Drawing - SOT23



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS $\boxed{-A-}$ AND $\boxed{-B-}$ TO BE DETERMINED AT DATUM PLANE $\boxed{-H-}$.
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

Land Pattern - SOT23



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
3. REFERENCE IPC-SM-782A.

PROTECTION PRODUCTS

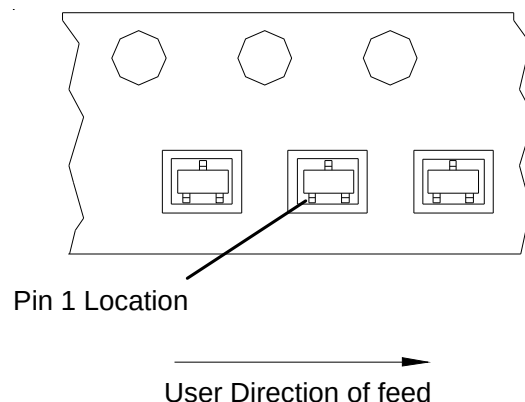
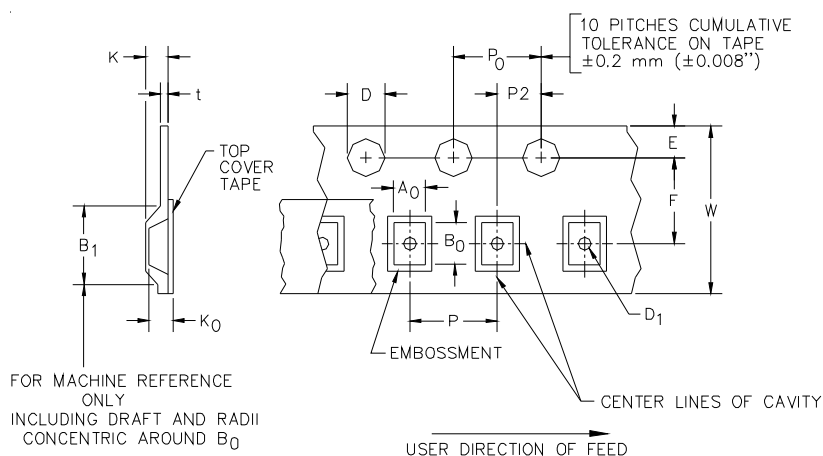
Marking Codes

Part Number	Marking Code
SM05	M05
SM12	M12
SM15	M15
SM24	M24
SM36	M36

Ordering Information

Part Number	Qty per Reel	Reel Size
SM05.TCT	3,000	7 Inch
SM12.TCT	3,000	7 Inch
SM15.TCT	3,000	7 Inch
SM24.TCT	3,000	7 Inch
SM36.TCT	3,000	7 Inch

Tape and Reel Specification



A0	B0	K0
3.15 +/-0.15 mm	2.77 +/-0.15 mm	1.22 +/-0.15 mm

Tape Width	B, (Max)	D	D1	E	F	K (MAX)	P	P0	P2	T(MAX)	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm	1.0 mm ±0.05	1.750±.10 mm	3.5±0.05 mm	2.4 mm	4.0±0.1 mm	4.0±0.1 mm	2.0±0.05 mm	0.4 mm	8.0 mm + 0.3 mm - 0.1 mm

Contact Information

Semtech Corporation
Protection Products Division
200 Flynn Road, Camarillo, CA 93012
Phone: (805)498-2111 FAX (805)498-3804